

STD37P3H6AG

Automotive-grade P-channel -30 V, 11 mΩ typ., -49 A STripFET™ H6 Power MOSFET in a DPAK package

Datasheet - production data

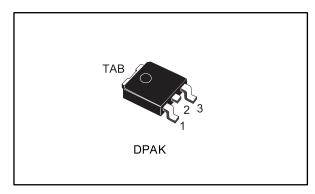
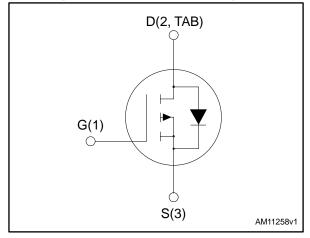


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	Ι _D	Ртот	
STD37P3H6AG	-30 V	15 mΩ	-49 A	60 W	

- Designed for automotive applications and AEC-Q101 qualified
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

Switching applications

Description

This device is a P-channel Power MOSFET developed using the STripFETTM H6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low $R_{DS(on)}$ in all packages.

Table 1: Device summary

Order code	Marking	Package	Packing
STD37P3H6AG	37P3H6	DPAK	Tape and Reel

Contents STD37P3H6AG

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STD37P3H6AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V_{DS}	Drain-source voltage	-30	V	
V_{GS}	Gate-source voltage	±20	V	
	Drain current (continuous) at T _{CASE} = 25 °C	-49	۸	
ID	Drain current (continuous) at T _{CASE} = 100 °C		Α	
I _{DM} ⁽¹⁾	Drain current (pulsed)	-196	Α	
P _{TOT}	Total dissipation at T _{\${casePCB}} = 25 °C	60	W	
E _{AS} ⁽²⁾	Single pulse avalanche energy	750	mJ	
T _{stg}	Storage temperature			
Tj	Operating junction temperature	-55 to 175	°C	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2.5 °C/W	
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50 °C	

Notes:

 $^{^{\}left(1\right) }$ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ starting T_j = 25 °C, I_D = -40 A, V_{DD} = 25 V.

 $^{^{(1)}}$ When mounted on a 1-inch² FR-4, 2 Oz copper board, t < 10 s.

Electrical characteristics STD37P3H6AG

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \text{ mA}$	-30			>
	Zoro goto voltago droin	$V_{GS} = 0 \text{ V}, V_{DS} = -30 \text{ V}$			-1	
I _{DSS}	I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = -30 \text{ V},$ $T_{CASE} = 125 \text{ °C}$			-10	μΑ
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = -20 V			-100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	-2		-4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = -10 V, I _D = -25 A		11	15	mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		ı	1630	ı	
Coss	Output capacitance	$V_{DS} = -25 \text{ V, f} = 1 \text{ MHz,}$	ı	376	ı	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	230	-	P.
Qg	Total gate charge	$V_{DD} = -15 \text{ V}, I_{D} = -40 \text{ A}, V_{GS} = -$	ı	30.6	ı	
Q_gs	Gate-source charge	10 V (see Figure 14: "Gate	•	9.7		nC
Q_{gd}	Gate-drain charge	charge test circuit")	1	10	•	

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = -15 V, I _D = -20 A	ı	13.4	ı	
t _r	Rise time	$R_{G} = 4.7 \Omega, V_{GS} = -10 V \text{ (see)}$	-	15.8	-	
t _{d(off)}	Turn-off delay time	Figure 13: "Switching times	-	23.6	-	ns
t _f	Fall time	test circuit for resistive load")	-	9.4	-	

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		-49	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		-196	Α
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = -40 \text{ A}$	-		-1.3	V
t _{rr}	Reverse recovery time	$I_{SD} = -40 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	25.3		ns
Qrr	Reverse recovery charge	V _{DD} = -24 V (see Figure 15: "Test circuit for inductive load	-	19.2		nC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	-1.5		А

Notes:

 $^{^{\}left(1\right) }$ Pulse width is limited by safe operating area.

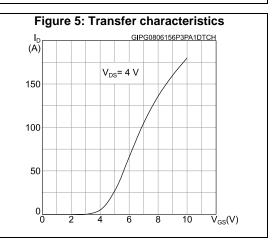
⁽²⁾ Pulse test: pulse duration = 300 μ s, duty cycle 1.5%.

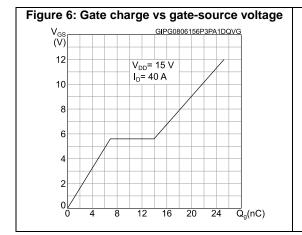
2.1 Electrical characteristics (curves)

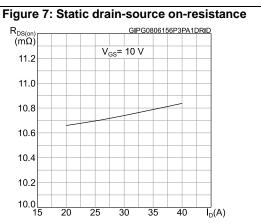


For the P-channel Power MOSFET, current and voltage polarities are reversed

Figure 3: Thermal impedance K GIPG0806156P3PA1DZTH δ =0.5 δ =0.05 δ =0.01 δ =0.01 δ =0.02 δ =0.01 δ =0.01 δ Single pulse δ =0.02 δ =10-1 δ =0.02 δ =0.01 δ =0.02 δ =0.01 δ =0.01 δ =0.01 δ =0.01 δ =0.02 δ =0.01 δ =0.02 δ =0.01 δ =0.01 δ =0.02 δ =0.01 δ =0.03 δ =0.03 δ =0.04 δ =0.05 δ =0.0







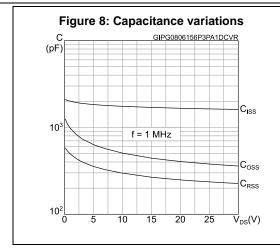


Figure 9: Normalized gate threshold voltage vs temperature

V_{GS(th)} GIPG0806156P3PA1DVTH
(norm.)

1.1

1.0

0.9

0.8

0.7

0.6

-100 -50 0 50 100 150 T_j(°C)

Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG0806156P3PA1DRON (norm.)

1.6

1.4

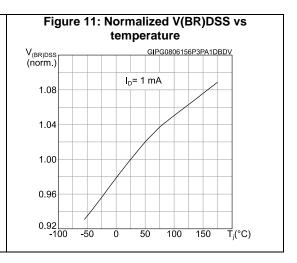
1.2

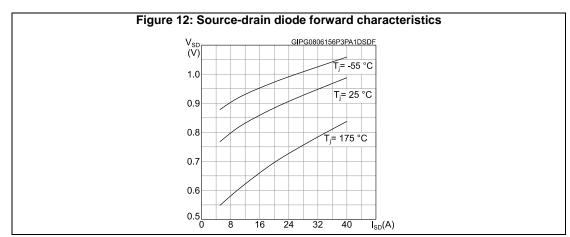
1.0

0.8

0.6

-100 -50 0 50 100 150 T_j(°C)







For the P-channel Power MOSFET, current and voltage polarities are reversed

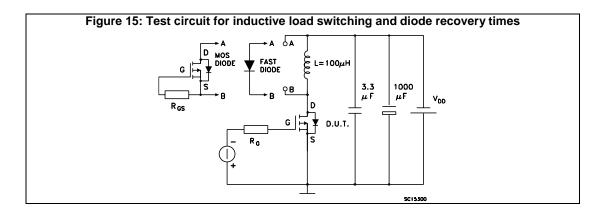
Test circuits STD37P3H6AG

3 Test circuits

Figure 13: Switching times test circuit for resistive load

Figure 14: Gate charge test circuit

Figure 14: Gate charge test circuit



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of $\mathsf{ECOPACK}^{\otimes}$ packages, depending on their level of environmental compliance. $\mathsf{ECOPACK}^{\otimes}$ specifications, grade definitions and product status are available at: $\mathit{www.st.com}$. $\mathsf{ECOPACK}^{\otimes}$ is an ST trademark.

4.1 DPAK (TO-252) type A2 package information

Figure 16: DPAK (TO-252) type A2 package outline

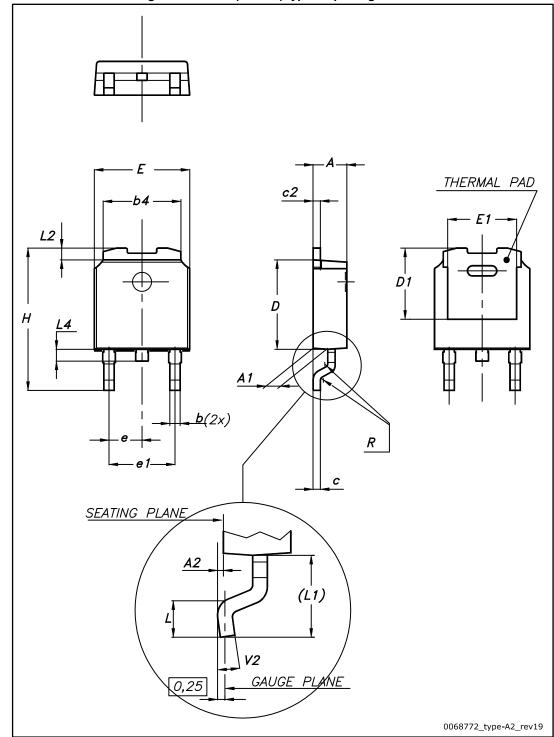


Table 8: DPAK (TO-252) type A2 mechanical data

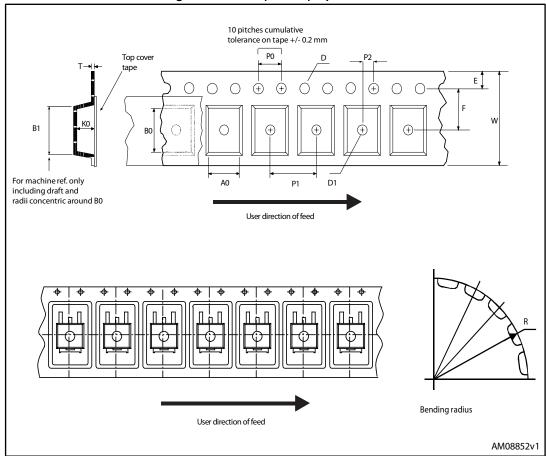
Dim	1450 61 51 711 (10 202	mm	
Dim.	Min.	Тур.	Max.
Α	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

Figure 17: DPAK (TO-252) recommended footprint (dimensions are in mm)

STD37P3H6AG Package information

4.2 DPAK (TO-252) packing information

Figure 18: DPAK (TO-252) tape outline



A 40mm min. access hole at slot location

Tape slot in core for tape start 2.5mm min.width

AM06038v1

Figure 19: DPAK (TO-252) reel outline

Table 9: DPAK (TO-252) tape and reel mechanical data

Table 9. DFAR (10-232) tape and reel mechanical data					
	Tape			Reel	
Dim.	n	nm	Dim.	r	nm
Dilli.	Min.	Max.	Diiii.	Min.	Max.
A0	6.8	7	А		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Base	e qty.	2500
P1	7.9	8.1	Bulk	qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

STD37P3H6AG Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
05-Aug-2015	1	Initial release

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